



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 1765 Examiner: Lan Vinh

In re PATENT APPLICATION of:

Applicant	:	Toyokazu SAKATA)	
Serial No.	:	10/721,260)	
Filed	:	November 26, 2003)	AMENDMENT AFTER FINAL
For	:	ETCHING METHOD AND SEMICONDUCTOR DEVICE FABRICATING METHOD)	REJECTION
Attorney Ref.	:	TAI 145)	April 4, 2006

Box AFCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of January 5, 2006, the period for reply to which has been set to expire on April 5, 2006.

A fee of \$ \(\int \) Deal is being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.